

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5946870

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JEONG HO PARK	01/31/2020
BU GON SHIN	01/31/2020
EUN KYU HER	01/31/2020
JUNG HWAN YOON	01/31/2020
SO YOUNG CHOO	01/31/2020
RECEIVING PARTY DATA	
Name:	LG CHEM, LTD,
Street Address:	128, YEOUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	07336
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16636469
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	mlaip@dentons.com
Correspondent Name:	DENTONS US LLP
Address Line 1:	1900 K. STREET, N.W.
Address Line 4:	WASHINGTON, D.C. 20006
ATTORNEY DOCKET NUMBER:	29137.02950.US00
NAME OF SUBMITTER:	SONG K. JUNG
SIGNATURE:	/Song K. Jung/
DATE SIGNED:	02/05/2020
Total Attachments: 2	
source=Assignment#page1.tif	
source=Assignment#page2.tif	

Assignment of Application

WHEREAS, WE	Jeong Ho PARK; Bu Gon SHIN; Eun Kyu HER; Jung Hwan YOON; and So Young CHOO
, respectively,	
have invented certain new and useful improvements in:	
METHOD OF MANUFACTURING MODULE HAVING MULTIPLE PATTERN AREAS, MODULE HAVING MULTIPLE PATTERN AREAS ACCORDING TO THE METHOD, AND METHOD OF MANUFACTURING DIFFRACTION GRATING MODULE OR MOLD FOR DIFFRACTION GRATING MODULE	
for which an application for Letters Patent was executed on	

(Application No.		, Filed		), and
WHEREAS,	LG CHEM, LTD.			
(hereinafter referred to as "ASSIGNEE") having a place of business at:				
128, Yeoui-daero, Yeongdeungpo-gu Seoul 07336 Republic of Korea				

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, for good and sufficient consideration, the receipt whereof is hereby acknowledged, I (WE) by these presents do assign, sell and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

AND for the same consideration, I (WE) hereby covenant and agree to and with said ASSIGNEE, its successors, legal representatives and assigns, that, at the time of execution and delivery of these presents, I (WE) lawfully own the entire right, title and interest in and to the said inventions and the United States patent application above mentioned, and that the same are unencumbered and that I (WE) have good and full right and lawful authority to sell and convey the same in the manner herein set forth.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the ASSIGNEE of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Dentons US LLP, Attorneys at Law, 1900 K Street, N.W., Washington, D.C. 20006 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: Jan. 31, 2020

Jeong-Ho Park
(Signature of Inventor)
Jeong Ho Park

Date: 31 / 01 / 2020

Bu Gon Shin
(Signature of Inventor)
Bu Gon Shin

Date: 31 / 01 / 2020

Eun Kyu Her
(Signature of Inventor)
Eun Kyu Her

Date: 31 / 01 / 2020

Jung Hwan Yoon
(Signature of Inventor)
Jung Hwan Yoon

Date: 31 / 01 / 2020

So Young Choo
(Signature of Inventor)
So Young Choo

Dentons US LLP
Attorneys At Law
1900 K Street, N.W.
Washington, D.C. 20006